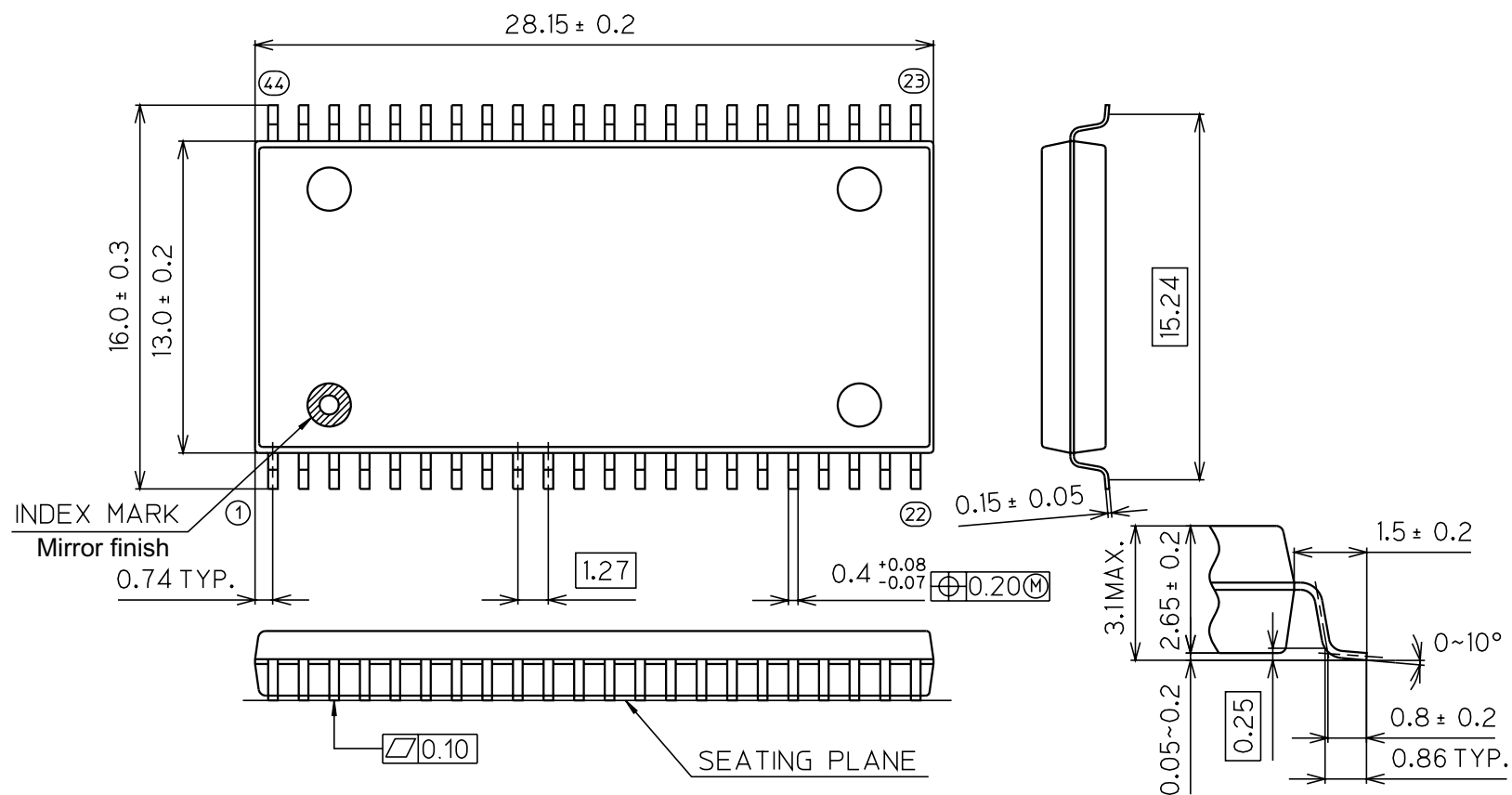


## SOP44-P-600-1.27-K



|                       |                                        |
|-----------------------|----------------------------------------|
| Package material      | Epoxy resin                            |
| Lead frame material   | 42 alloy                               |
| Pin treatment         | Solder plating ( $\geq 5\mu\text{m}$ ) |
| Package weight (g)    | 2.10 TYP.                              |
| Rev. No./Last Revised | 4/Dec. 5, 1996                         |

Oki Electric Industry Co., Ltd.